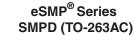
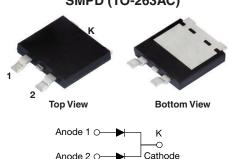


Ultrafast Rectifier, 2 x 6 A FRED Pt®





LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|----------------------------------|-----------------|--|--|--|
| I _{F(AV)} | 2 x 6 A | | | |
| V_{R} | 600 V | | | |
| V _F at I _F | 0.89 V | | | |
| t _{rr} | 45 ns | | | |
| T _J max. | 175 °C | | | |
| Package | SMPD (TO-263AC) | | | |
| Circuit configuration | Common cathode | | | |

FEATURES

Ultrafast recovery time, reduced Q_{rr}, and soft recovery



• 175 °C maximum operating junction temperature

• For PFC CRM, snubber operation

COMPLIANT HALOGEN FREE

- Low forward voltage drop
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art ultrafast recovery rectifiers specifically designed with optimized performance of forward voltage drop, ultrafast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in PFC, boost, in the AC/DC section of SMPS, freewheeling and clamp diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per

J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|-------------------------------------|------------|----------------------|---|--------|-------|
| PARAMETER | | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Peak repetitive reverse voltage | | V_{RRM} | | 600 | V |
| Average rectified forward current | per device | - I _{F(AV)} | T _{solder pad} = 156 °C | 12 | |
| | per diode | | | 6 | ^ |
| Nieuwanatiki na maala ahuma ahumant | per device | I _{FSM} | T _J = 25 °C, 6 ms square pulse | 200 | A |
| Non-repetitive peak surge current | per diode | | | 105 | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | |
|--|--------------------|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR} , V_{R} | I _R = 100 μA | 600 | - | - | |
| Converse valtage per diade | M | I _F = 6 A | - | 1.05 | 1.3 | V |
| Forward voltage, per diode | V _F | I _F = 6 A, T _J = 150 °C | - | 0.89 | 1.1 | |
| Reverse leakage current, per diode I _R | | V _R = V _R rated | - | - | 5 | |
| | | $T_J = 150 ^{\circ}\text{C}, V_R = V_R \text{rated}$ | - | 20 | 150 | μΑ |
| Junction capacitance, per diode | C _T | $V_{R} = 600 \text{ V}$ | - | 8 | - | pF |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|---|------------------|---|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| | | $I_F = 1 A, dI_F/dt = 50 A$ | Vμs, V _R = 30 V | - | 45 | - | |
| Reverse recovery time | t _{rr} | $I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$ | | - | - | 60 | 1 |
| | | T _J = 25 °C | $I_F = 6 \text{ A},$ $dI_F/dt = 500 \text{ A/}\mu\text{s},$ $V_B = 400 \text{ V}$ | - | 65 | - | ns |
| | | T _J = 125 °C | | - | 90 | - | |
| Peak recovery current | I _{RRM} | T _J = 25 °C | | - | 10 | - | A |
| | | T _J = 125 °C | | - | 15 | - | |
| Deverge vecesions above | 0 | T _J = 25 °C |] '' | - | 350 | - | nC |
| Reverse recovery charge | Q_{rr} | T _J = 125 °C | | - | 680 | - | 110 |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|---|-----------------------------------|----------------------------|---------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -55 | - | +175 | °C |
| Thermal resistance, per diode junction to mount | R _{thJM} | | - | 1.8 | 2.5 | °C/W |
| Approximate weight | | | | 0.55 | | g |
| Approximate weight | | | | 0.02 | | oz. |
| Marking device | | Case style SMPD (TO-263AC) | 12CDU06 | | | |

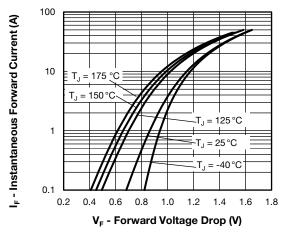


Fig. 1 - Typical Forward Voltage Drop Characteristics

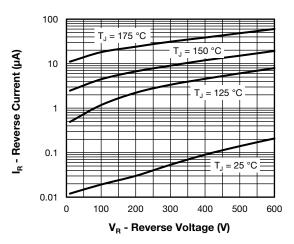


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

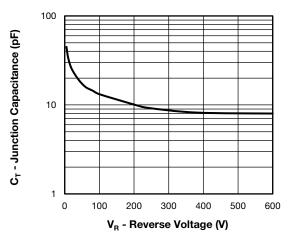


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

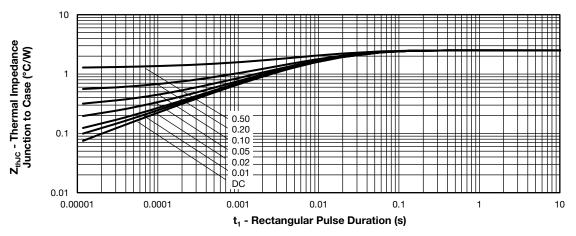


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

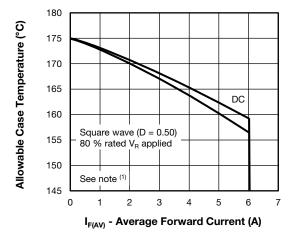


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

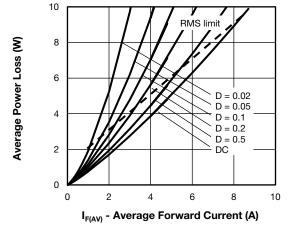


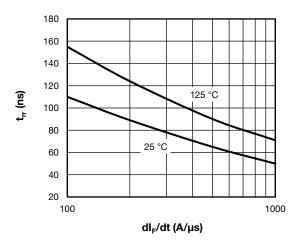
Fig. 6 - Forward Power Loss Characteristics

Note

 $[\]begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (\text{Pd} + \text{Pd}_{\text{REV}}) \times R_{\text{thJC}}; \\ \text{Pd} = & \text{forward power loss} = I_{\text{F(AV)}} \times V_{\text{FM}} \text{ at } (I_{\text{F(AV)}}/D) \text{ (see fig. 5)}; \\ \text{Pd}_{\text{REV}} = & \text{inverse power loss} = V_{\text{R1}} \times I_{\text{R}} \text{ (1 - D)}; I_{\text{R}} \text{ at } V_{\text{R1}} = \text{rated } V_{\text{R}} \\ \end{array}$

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Vishay Semiconductors





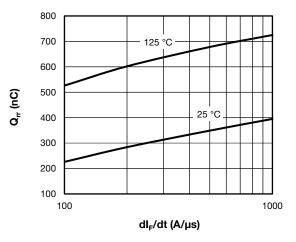
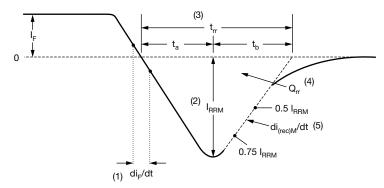


Fig. 8 - Typical Stored Charge vs. dl_F/dt



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) $\mathbf{Q}_{\rm rr}$ area under curve defined by $\mathbf{t}_{\rm rr}$ and $\mathbf{I}_{\rm RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

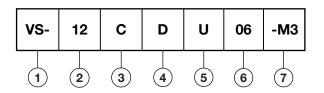
(5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

Current rating (12 A)

Circuit configuration:

C = common cathode

4 - D = SMPD package

5 - Process type,

U = ultrafast recovery

Voltage code (06 = 600 V)

7 - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

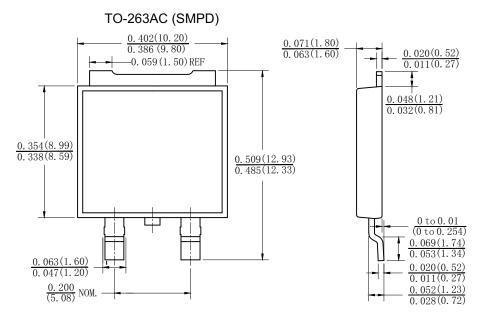
| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-------------------|------------------------|------------------------------------|--|--|
| PREFERRED P/N | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | |
| VS-12CDU06-M3/I | 2000 | 2000 | 13" diameter plastic tape and reel | | |

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?95604 | | | |
| Part marking information | www.vishay.com/doc?95566 | | | |
| Packaging information | www.vishay.com/doc?88869 | | | |

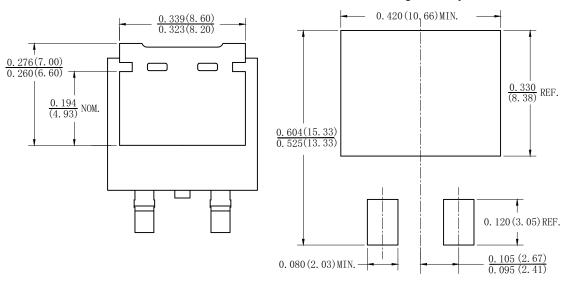


TO-263AC (SMPD)

DIMENSIONS in inches (millimeters)



Mounting Pad Layout





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